US00D754010S

(12) **United States Design Patent**
Shen

(10) **Patent No.: US D754,010 S**
(45) **Date of Patent: ** Apr. 19, 2016**

(54) **DIGITAL MULTIMETER**

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(**) Term: **14 Years**

(21) Appl. No.: **29/519,136**

(22) Filed: **Mar. 2, 2015**

Related U.S. Application Data

(63) Continuation of application No. 29/476,733, filed on Dec. 16, 2013, now Pat. No. Des. 723,401.

(30) **Foreign Application Priority Data**

Jun. 19, 2013 (CN) 2013 3 0263248

(51) **LOC (10) Cl.** **10-04**

(52) **U.S. Cl.**
USPC **D10/78**

(58) **Field of Classification Search**
USPC D10/78
CPC G01R 1/22; G01R 1/04; G01R 15/125; G01R 15/181; G01R 15/186; G01R 15/12; G01R 15/04; G01R 15/06; G01R 19/2503; G01R 1/20; G01R 1/203; G01R 1/206; G01R 1/24; G01R 1/26; G01D 11/24; G06F 17/00
See application file for complete search history.

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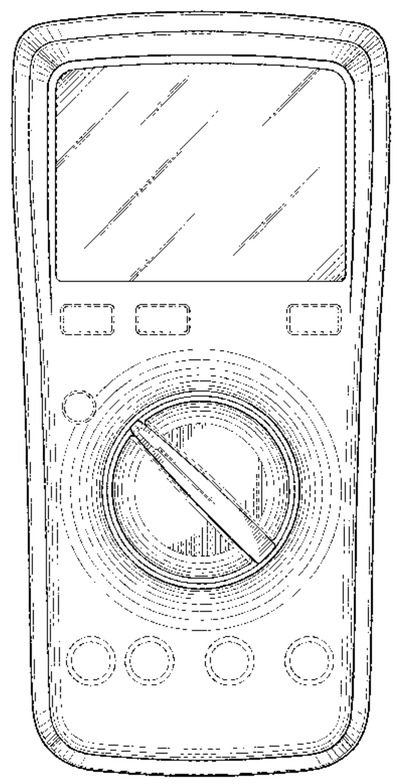
(57) **CLAIM**

The ornamental design for a digital multimeter, as shown and described.

DESCRIPTION

FIG. **1** is a front elevation view of a digital multimeter showing my new design;
FIG. **2** is a rear elevation view thereof;
FIG. **3** is a left side elevation view thereof;
FIG. **4** is a right side elevation view thereof;
FIG. **5** is a top plan view thereof;
FIG. **6** is a bottom plan view thereof;
FIG. **7** is a bottom front right perspective view thereof;
FIG. **8** is a front elevation view of another embodiment of a digital multimeter showing my new design;
FIG. **9** is a rear elevation view thereof;
FIG. **10** is a left side elevation view thereof;
FIG. **11** is a right side elevation view thereof;
FIG. **12** is a top plan view thereof;
FIG. **13** is a bottom plan view thereof;
FIG. **14** is a bottom front right perspective view thereof;
FIG. **15** is a front elevation view of another embodiment of a digital multimeter showing my new design;
FIG. **16** is a rear elevation view thereof;
FIG. **17** is a left side elevation view thereof;
FIG. **18** is a right side elevation view thereof;
FIG. **19** is a top plan view thereof;
FIG. **20** is a bottom plan view thereof; and,
FIG. **21** is a bottom front right perspective view thereof.
The broken line showing of structural features is included for the purpose of illustrating non-claimed subject matter and forms no part of the claimed design.

1 Claim, 15 Drawing Sheets



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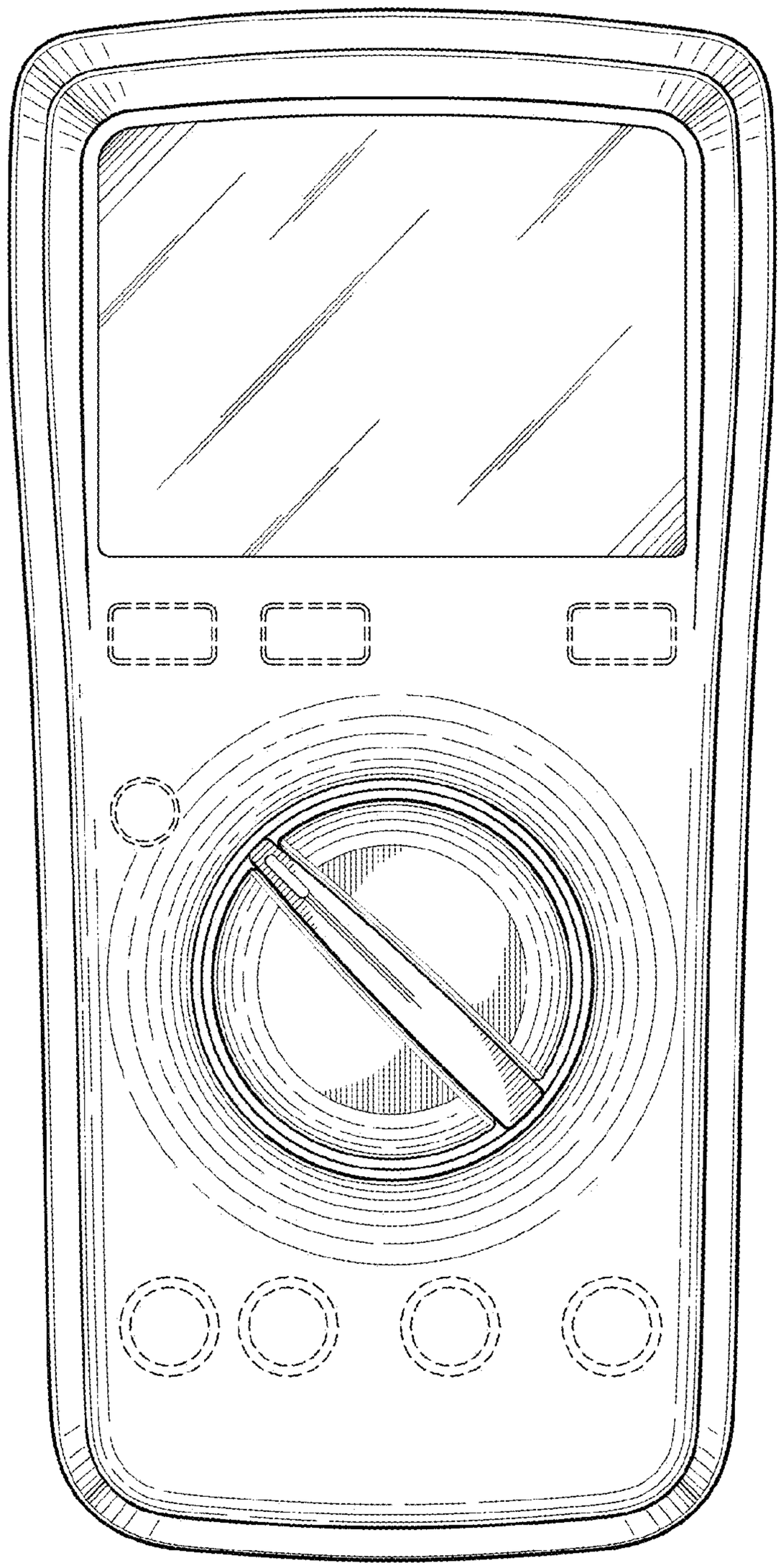


Fig. 1.

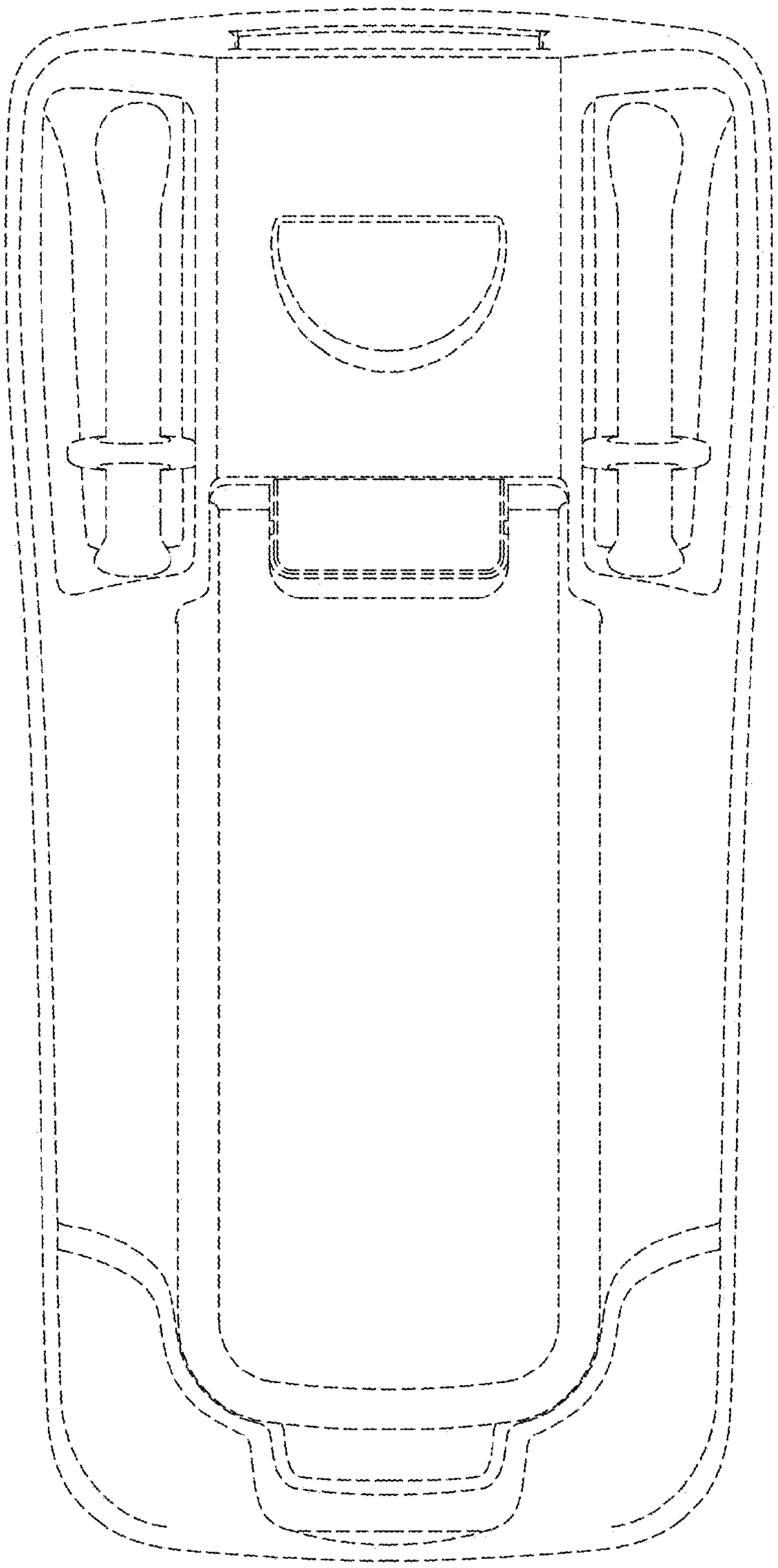


Fig. 2.

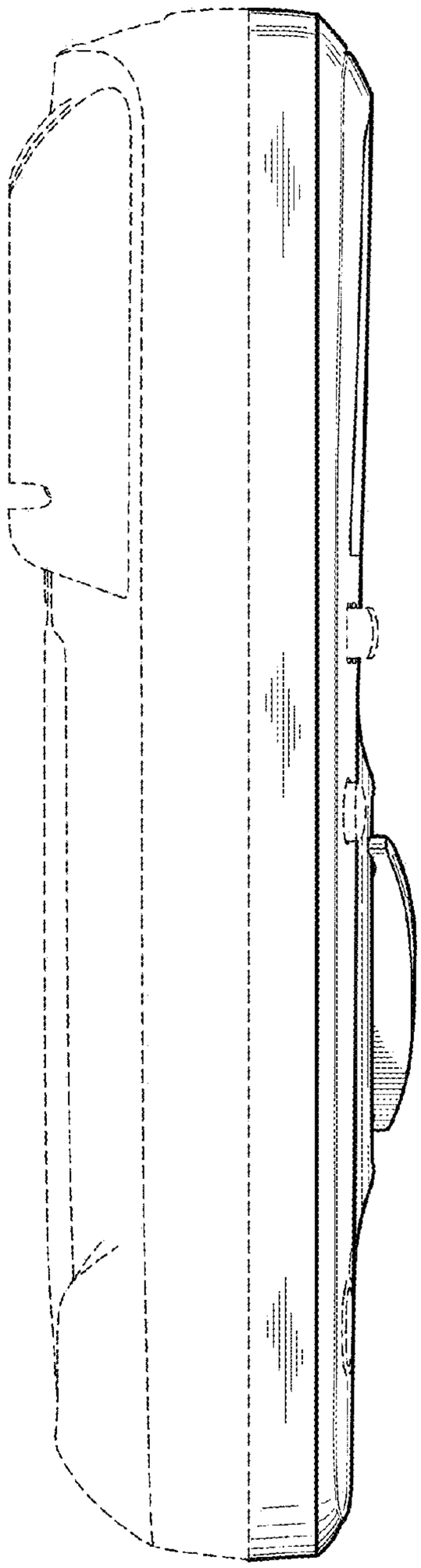
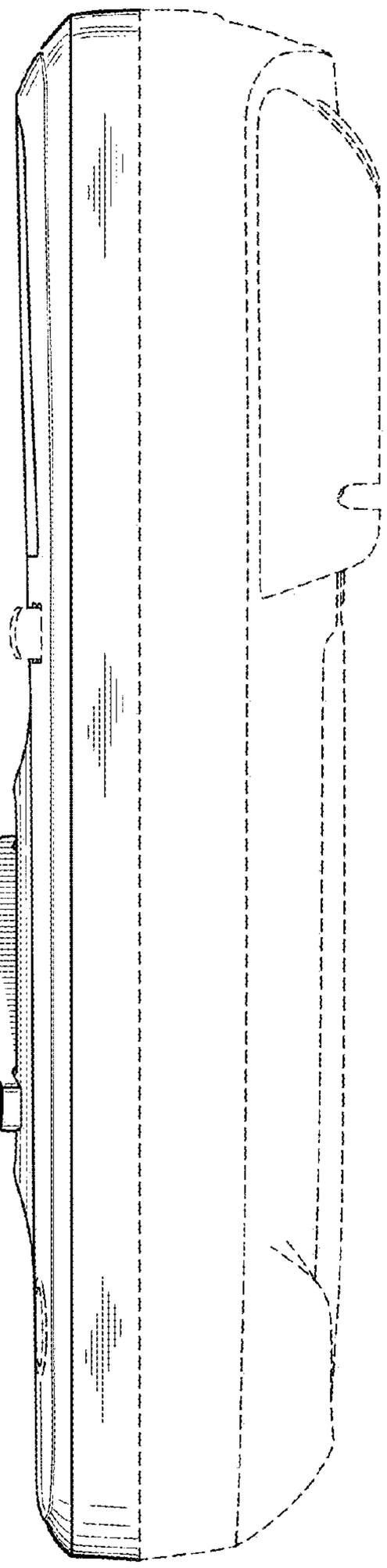


Fig. 3.



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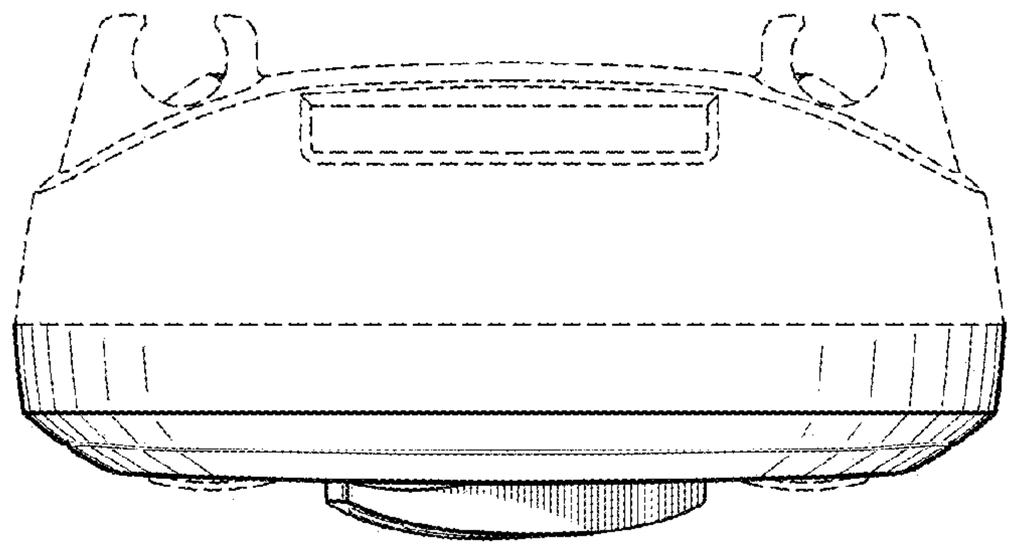
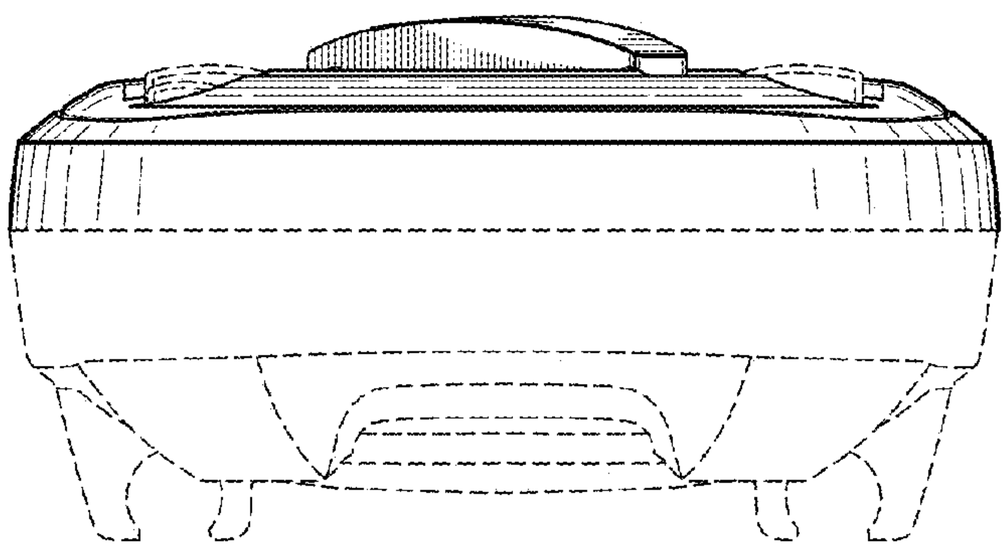


Fig. 5.



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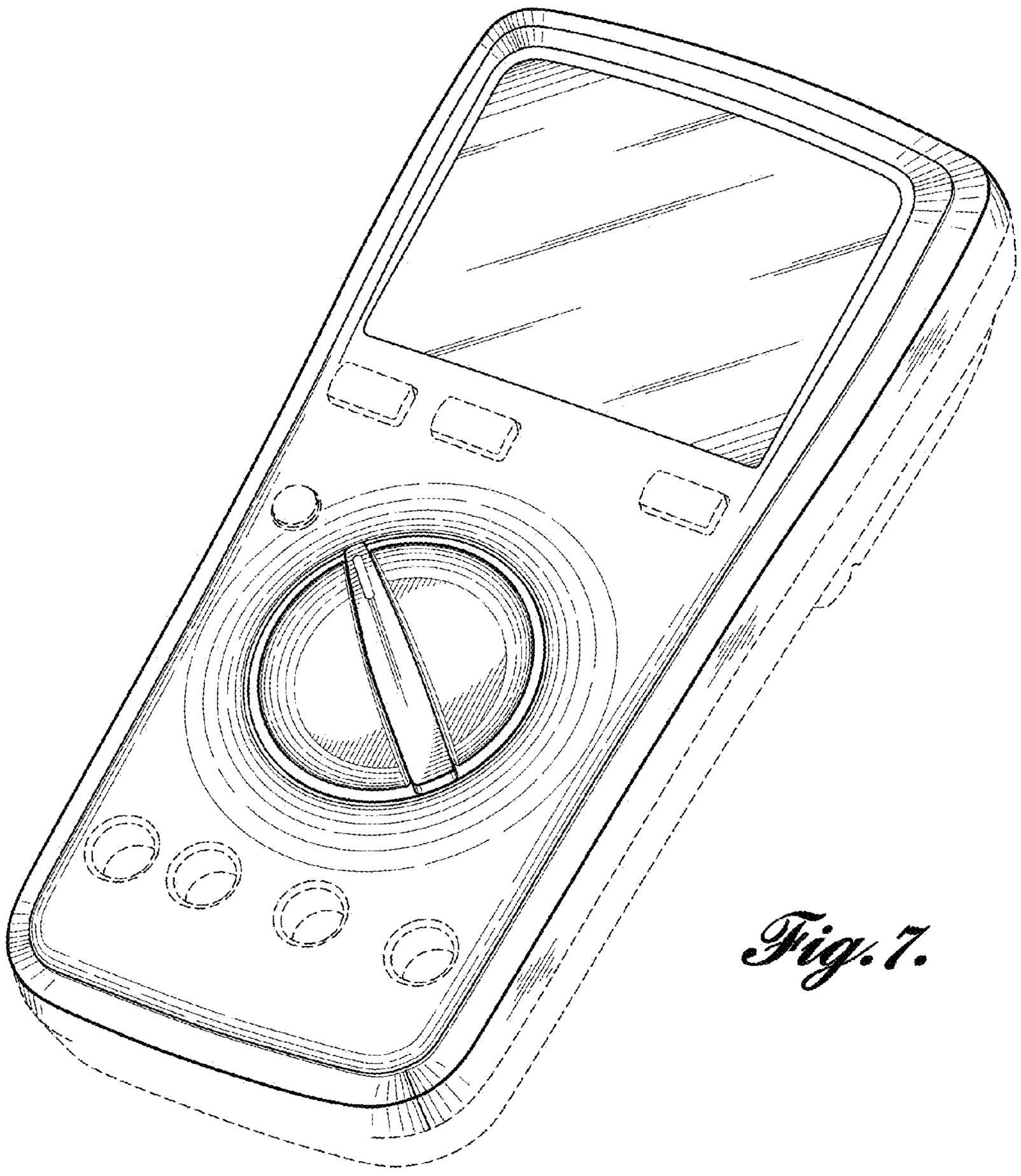

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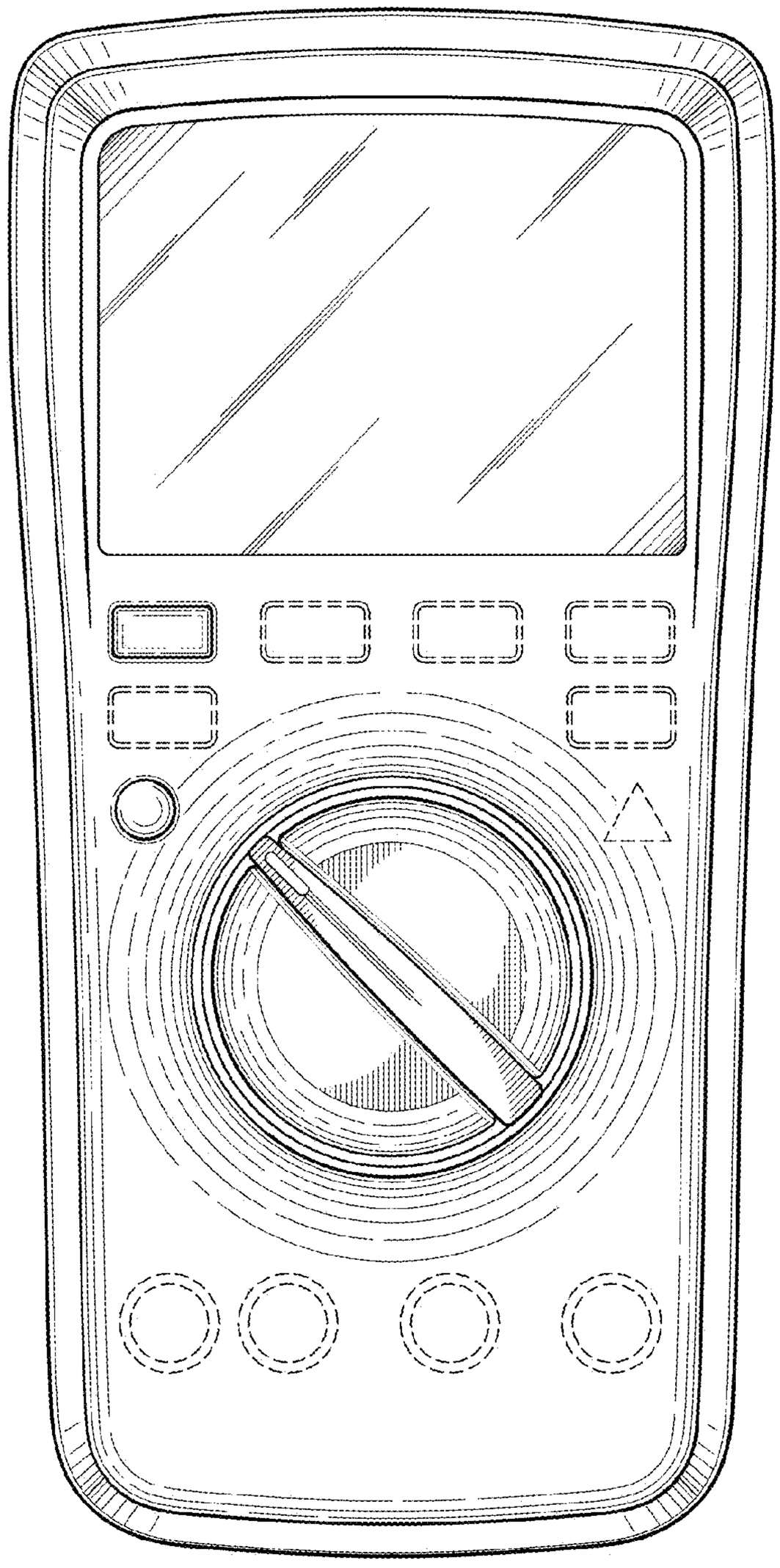

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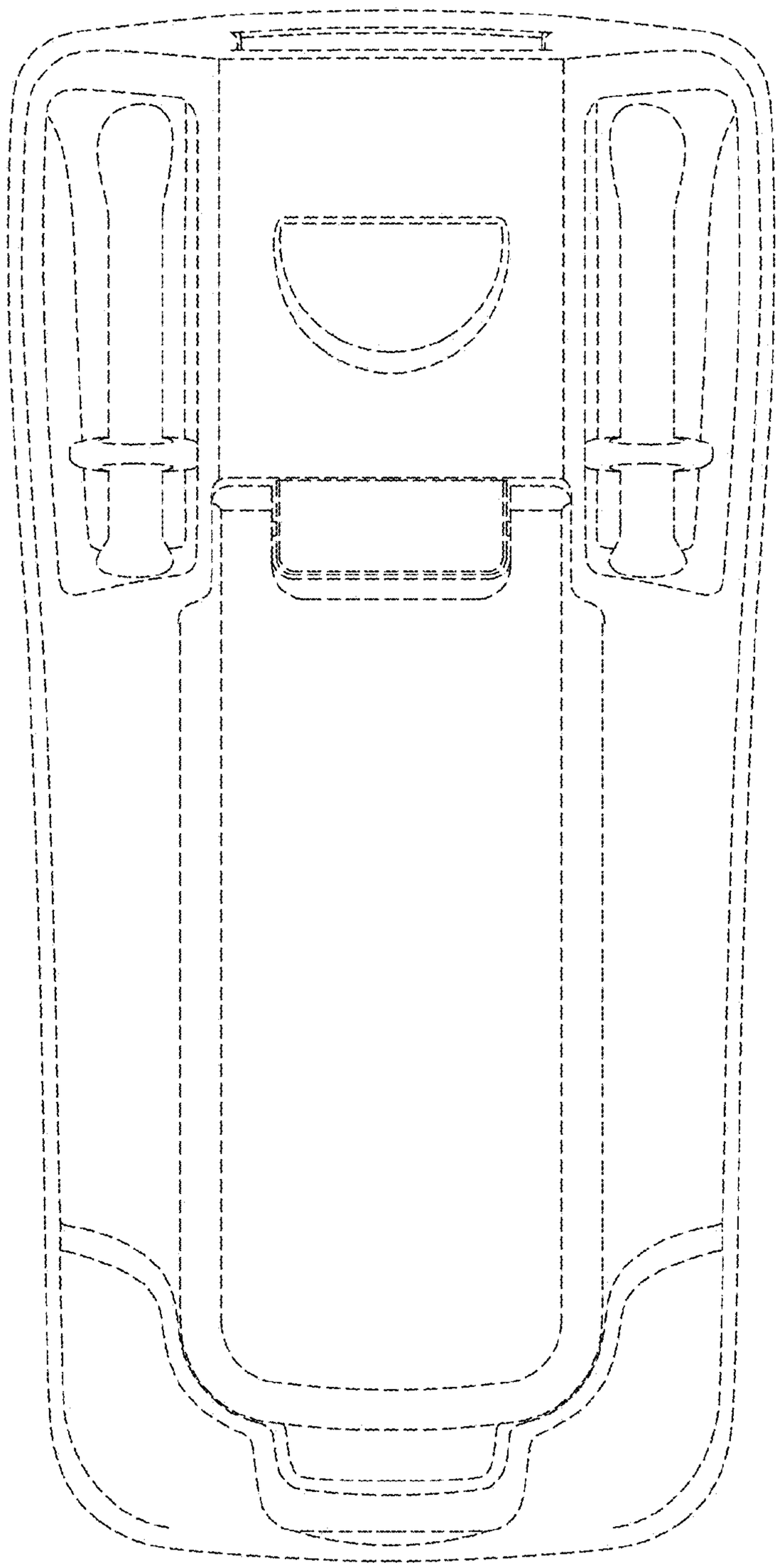

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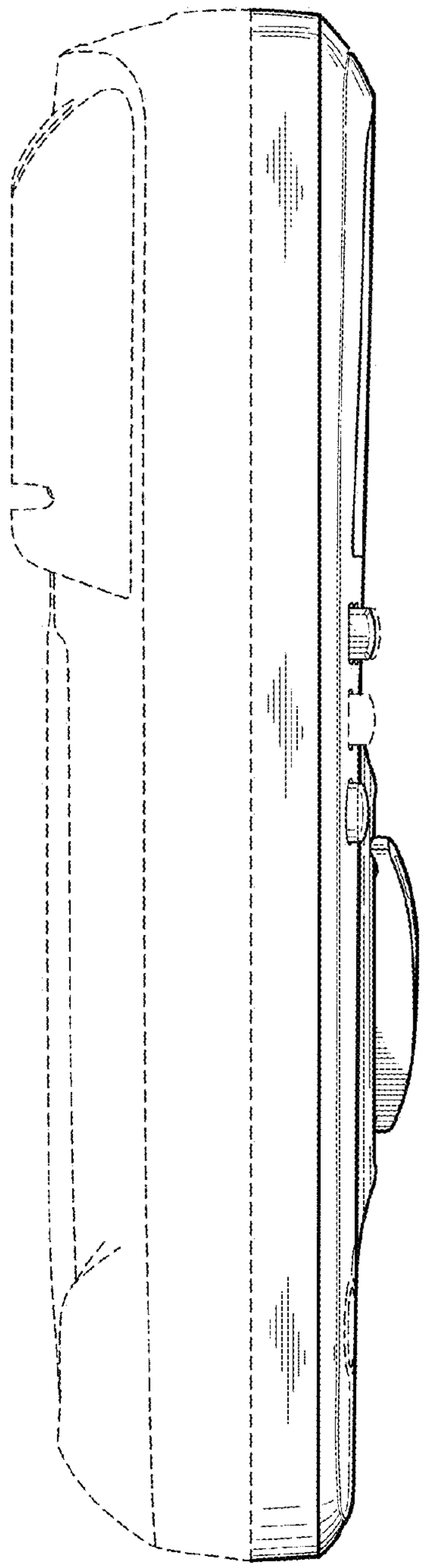

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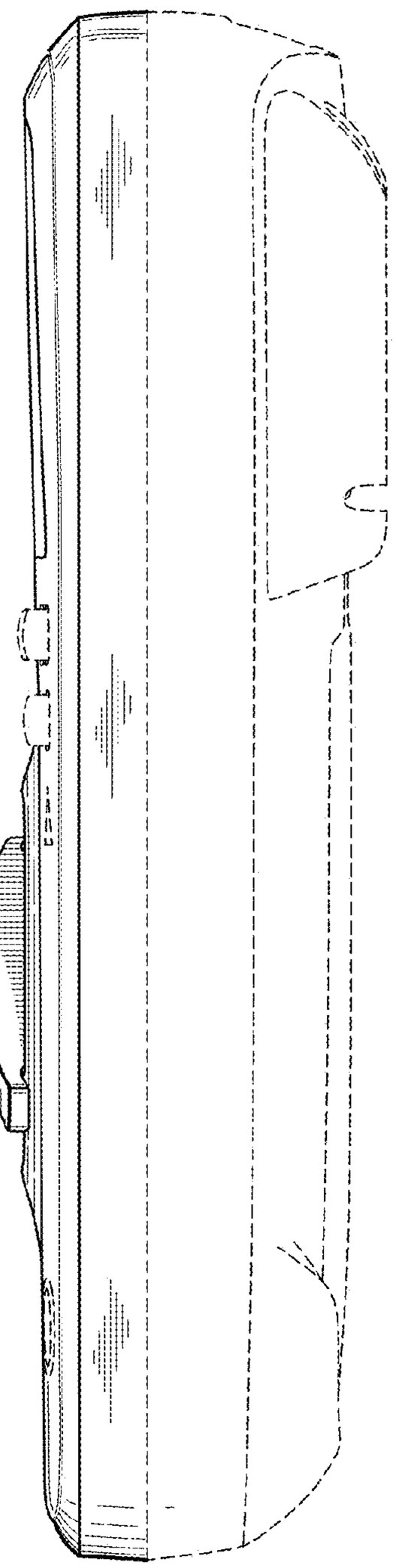

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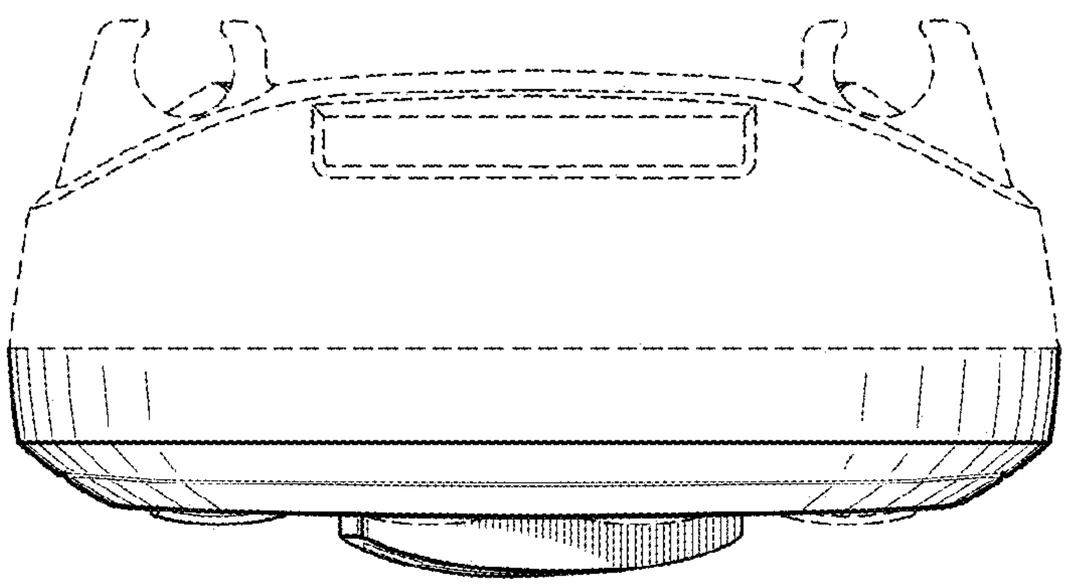

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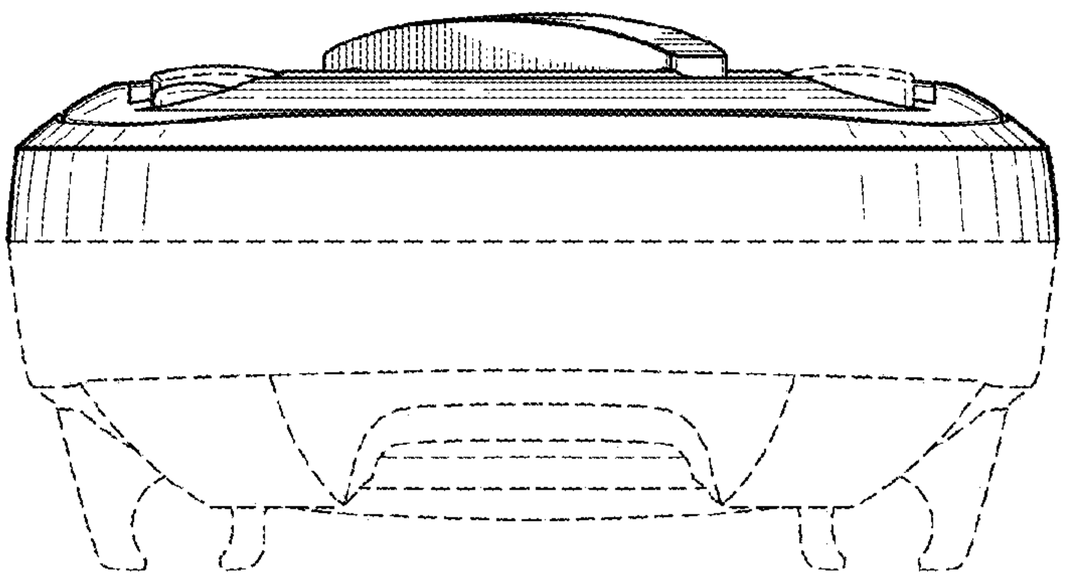

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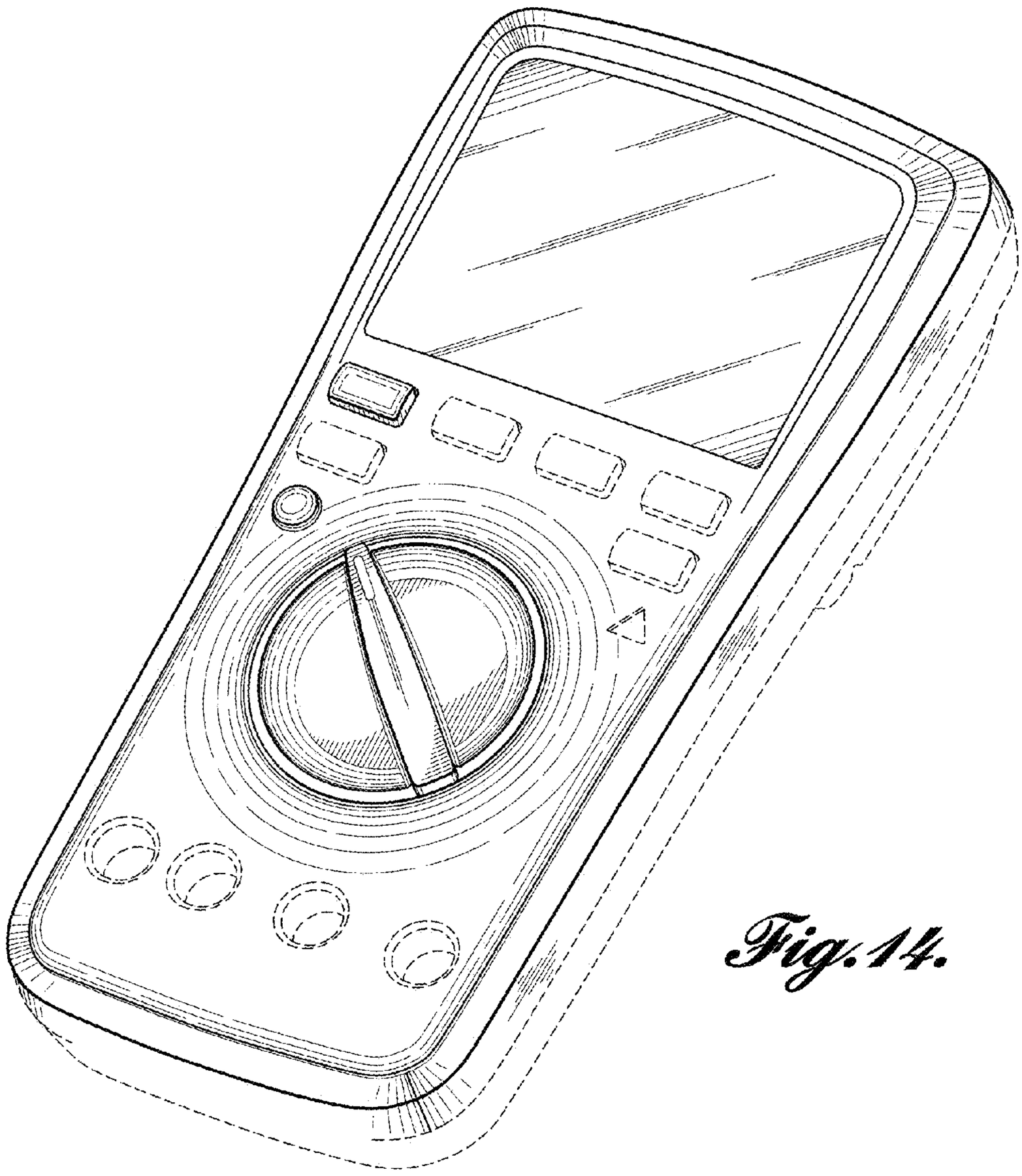

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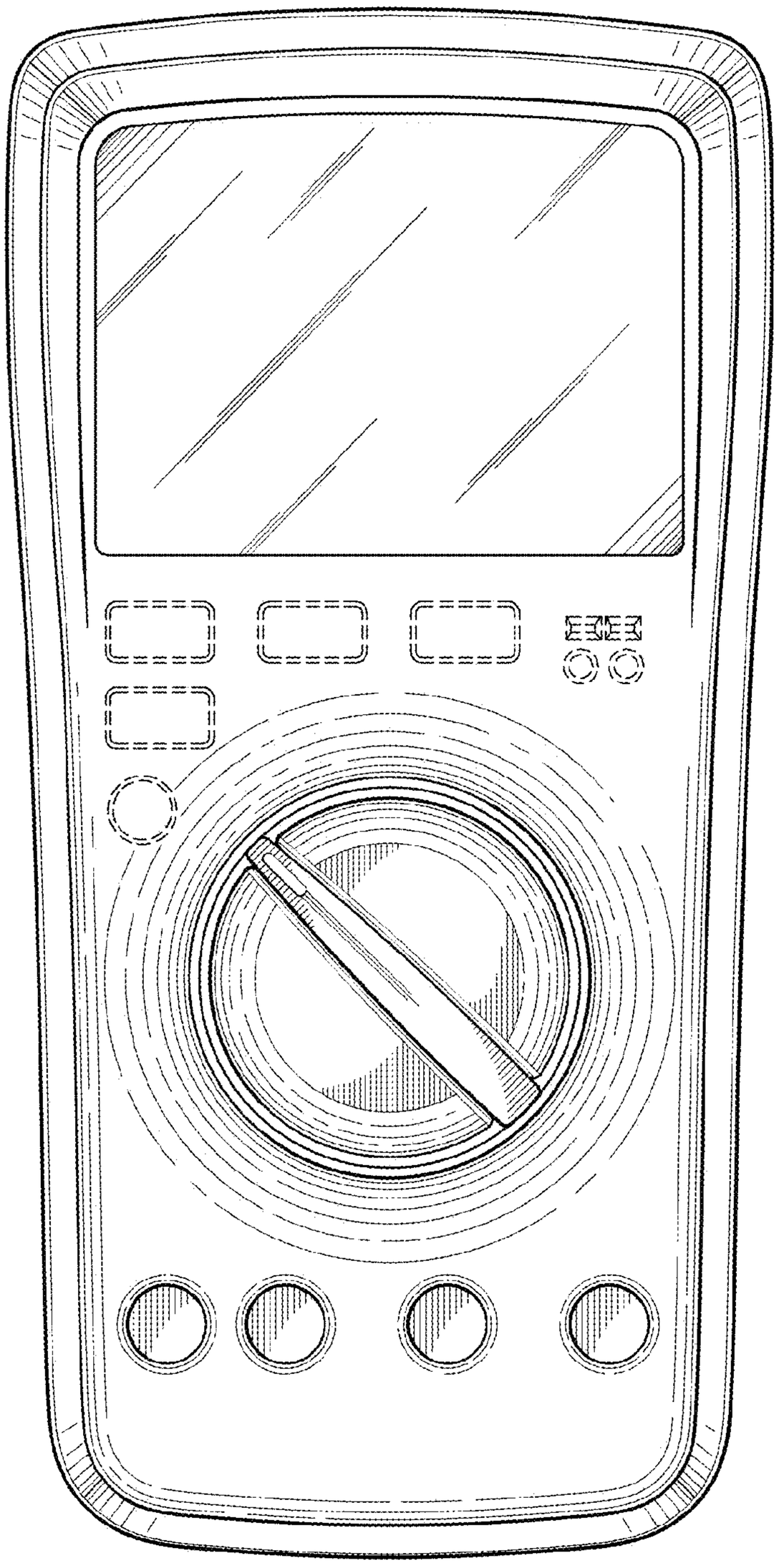

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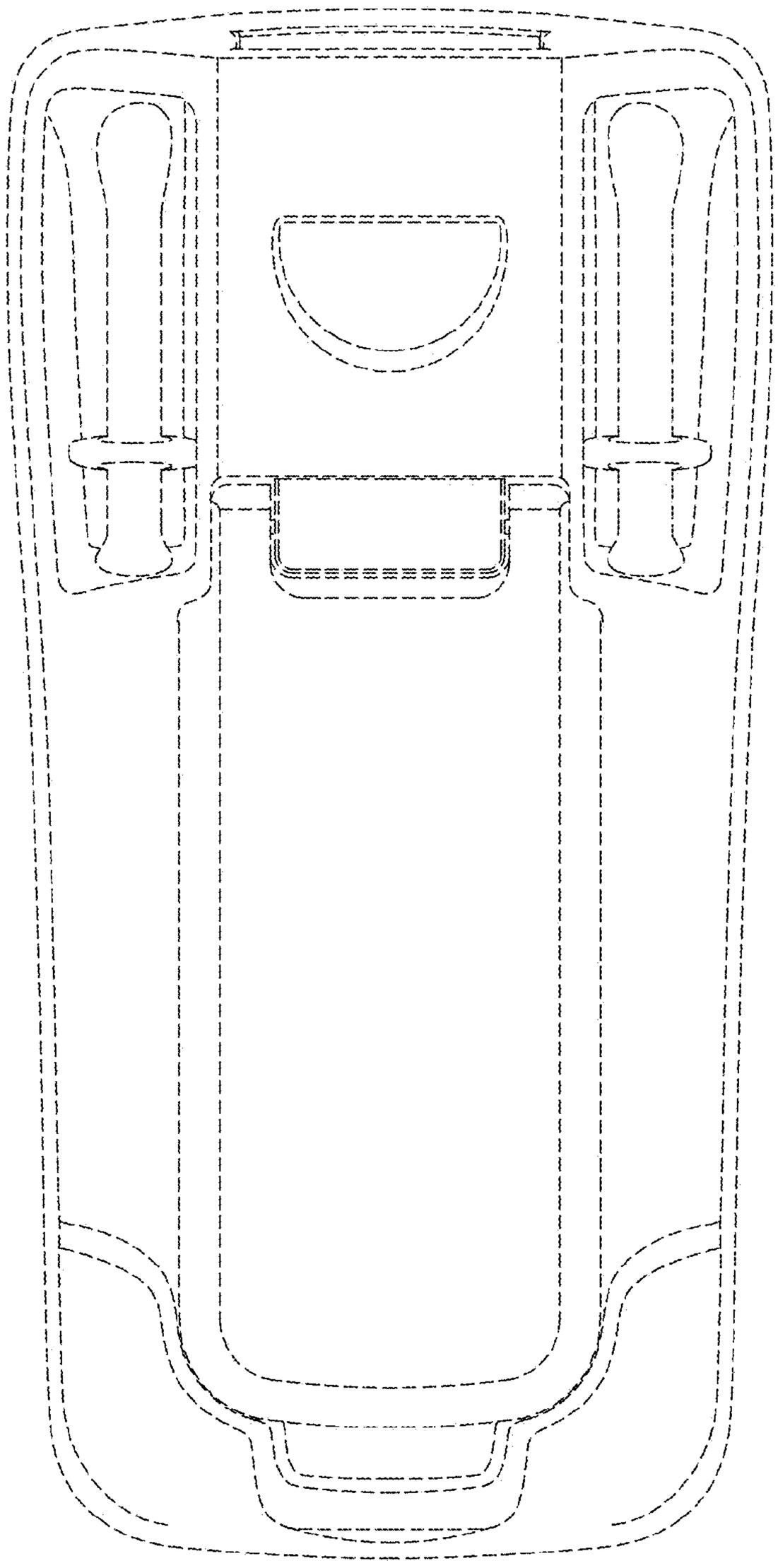

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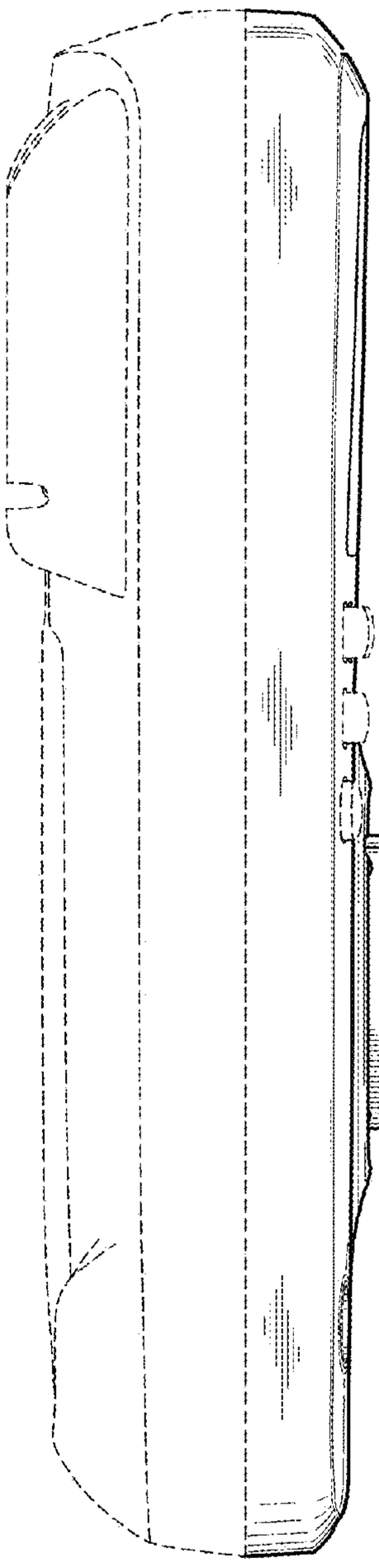

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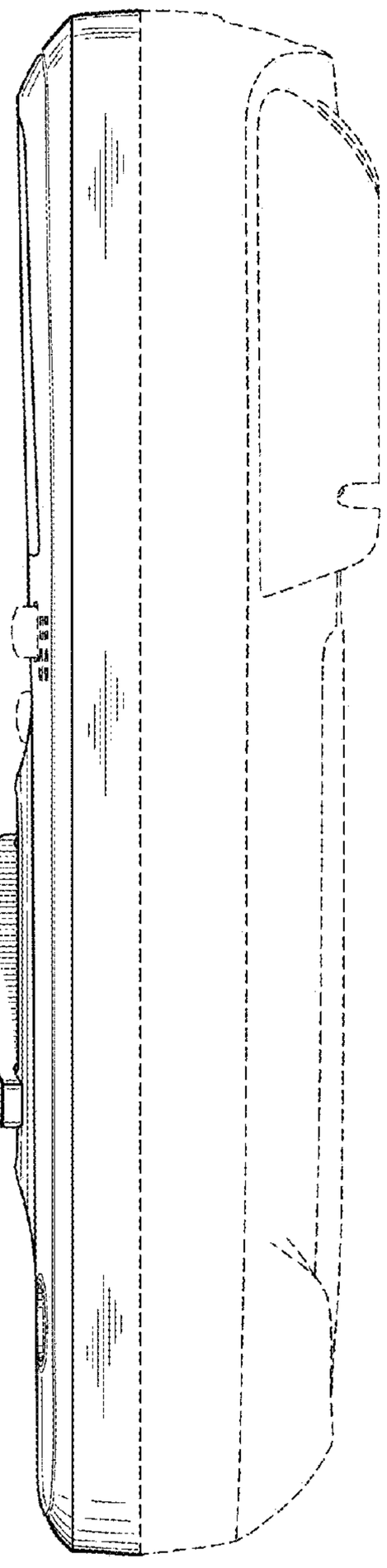

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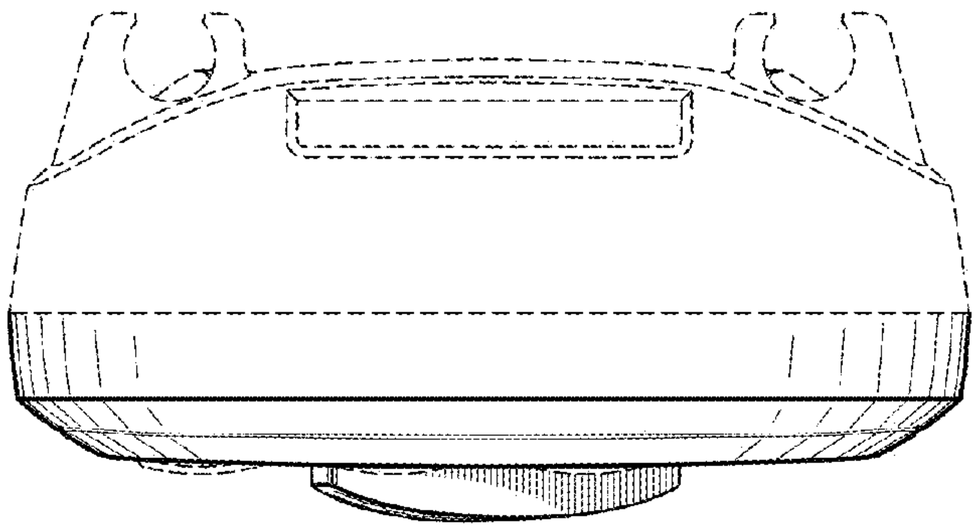

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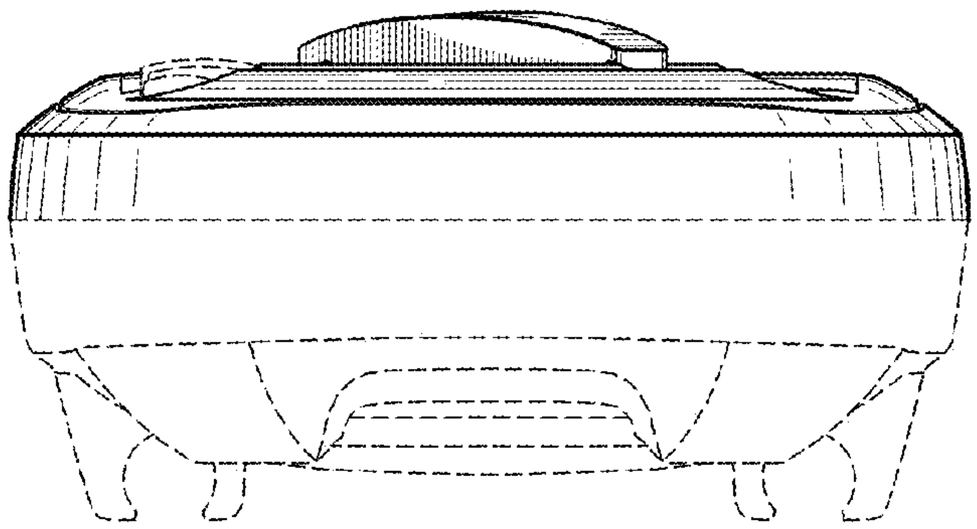

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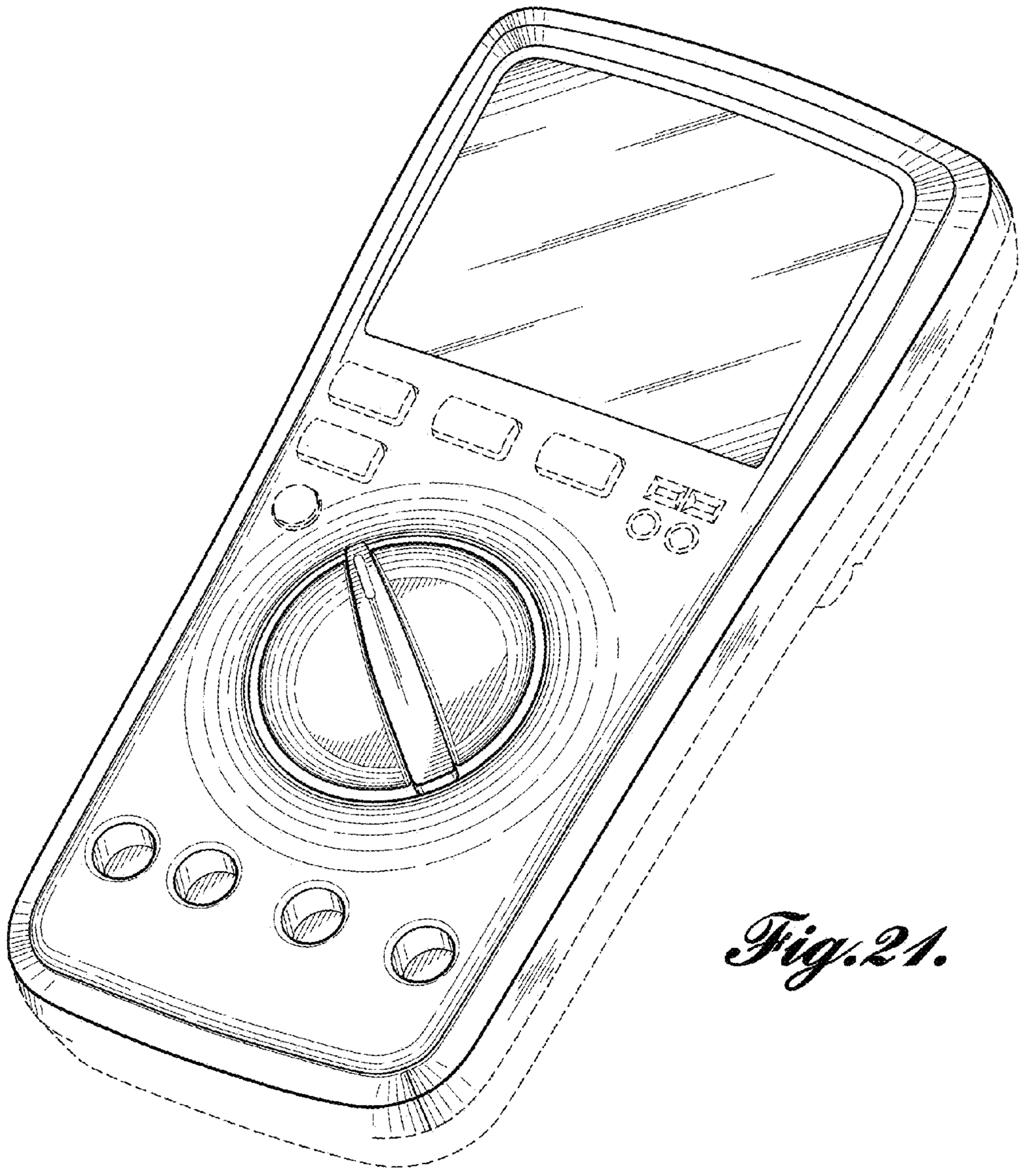

Fig. 21.